Hyperfast Diode

30 A, 1200 V

RHRG30120

Description

The RHRG30120 is a hyperfast diode with soft recovery characteristics. It has the half recovery time of ultrafast diodes and is silicon nitride passivated ionimplanted epitaxial planar construction. These devices are intended to be used as freewheeling/clamping diodes and diodes in a variety of switching power supplies and other power switching applications. Their low stored charge and hyperfast soft recovery minimize ringing and electrical noise in many power switching circuits reducing power loss in the switching transistors.

Features

- Hyperfast Recovery $t_{rr} = 85 \text{ ns} (@ I_F = 30 \text{ A})$
- Max Forward Voltage, $V_F = 3.2 V (@ T_C = 25^{\circ}C)$
- 1200 V Reverse Voltage and High Reliability
- Avalanche Energy Rated
- This Device is Pb-Free and is RoHS Compliant

Applications

- Switching Power Supplies
- Power Switching Circuits
- General Purpose

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C unless otherwise noted)

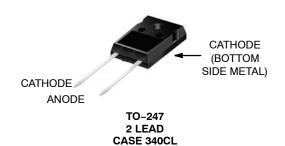
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	1200	V
Working Peak Reverse Voltage	V _{RWM}	1200	V
DC Blocking Voltage	V _R	1200	V
Average Rectified Forward Current $(T_C = 80^{\circ}C)$	I _{F(AV)}	30	A
Repetitive Peak Surge Current (Square Wave, 20 kHz)	I _{FRM}	60	A
Nonrepetitive Peak Surge Current (Halfwave, 1 Phase, 60 Hz)	I _{FSM}	300	A
Maximum Power Dissipation	PD	125	W
Avalanche Energy (See Figures 7 and 8)	E _{AVL}	30	mJ
Operating and Storage Temperature	T _{STG} , T _J	-65 to 175	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

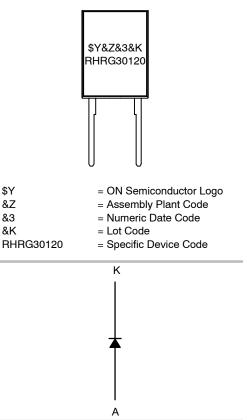


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MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

RHRG30120

PACKAGE MARKING AND ORDERING INFORMATION

Device	Device Marking	Package	Shipping
RHRG30120	RHRG30120	TO-247-2L	450/Tube

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
	Instantaneous Forward Voltage (Pulse Width = 300 μ s, Duty Cycle = 2%)	I _F = 30 A			3.2	V
		I _F = 30 A, T _C = 150°C			2.6	V
I _R	Instantaneous Reverse Current	V _R = 1200 V			250	μA
		V _R = 1200 V T _C = 150°C			1	mA
t _{rr}	Reverse Recovery Time (See Figure 6) Summation of $t_{a}^{}$ + $t_{b}^{}$	I _F = 1 A, di _F /dt = 100 A/μs			65	ns
		I _F = 30 A, di _F /dt = 100 A/μs			85	ns
t _a	Time to Reach Peak Reverse Current (See Figure 6)	I _F = 30 A, di _F /dt = 100 A/μs		48		ns
t _b	Time from Peak I_{RM} to Projected Zero Crossing of I_{RM} Based on a Straight Line from Peak I_{RM} Through 25% of I_{RM} (See Figure 6)	I _F = 30 A, di _F /dt = 100 A/μs		22		ns
$R_{ ext{ heta}JC}$	Thermal Resistance Junction to Case				1.2	°C/W

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

RHRG30120

TYPICAL PERFORMANCE CURVES

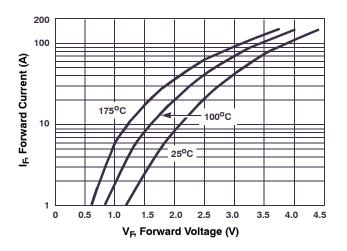


Figure 1. Forward Current vs. Forward Voltage

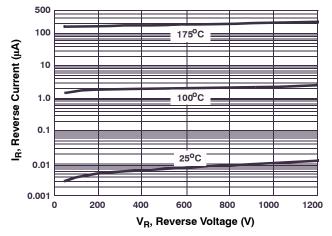


Figure 2. Reverse Current vs. Reverse Voltage

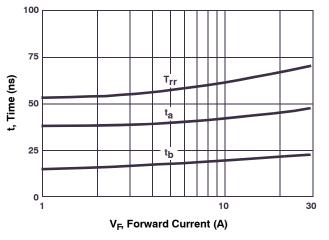


Figure 3. $T_{rr}\!,\,t_a$ and t_b Curves vs. Forward Current

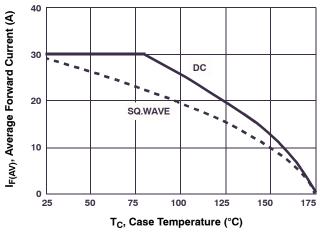
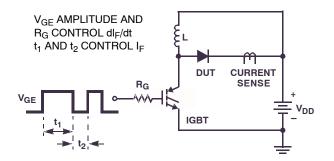


Figure 4. Current Derating Curve

RHRG30120

TEST CIRCUITS AND WAVEFORMS





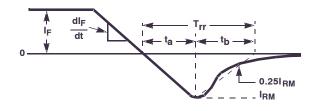


Figure 6. T_{rr} Waveforms and Definitions

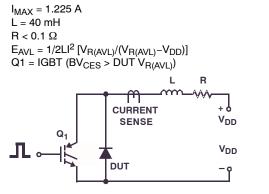


Figure 7. Avalanche Energy Test Circuit

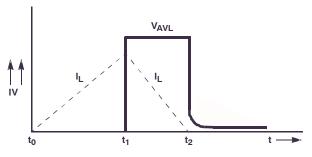


Figure 8. Avalanche Current and Voltage Waveforms

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MILLIMETERS

NOM

4.70

2.40

1.50

1.26

1.65

0.61

20.57

16.57

0.93

15.62

~

5.08

11.12

16.00

3.81

3.58

6.73

5.46

5.46

MAX

4.82

2.66

1.70

1.35

1.77

0.71

20.82

16.77

1.35

15.87

~

5.20

~

16.25

3.93

3.65

6.85

5.58

5.58

PAGE 1 OF 1

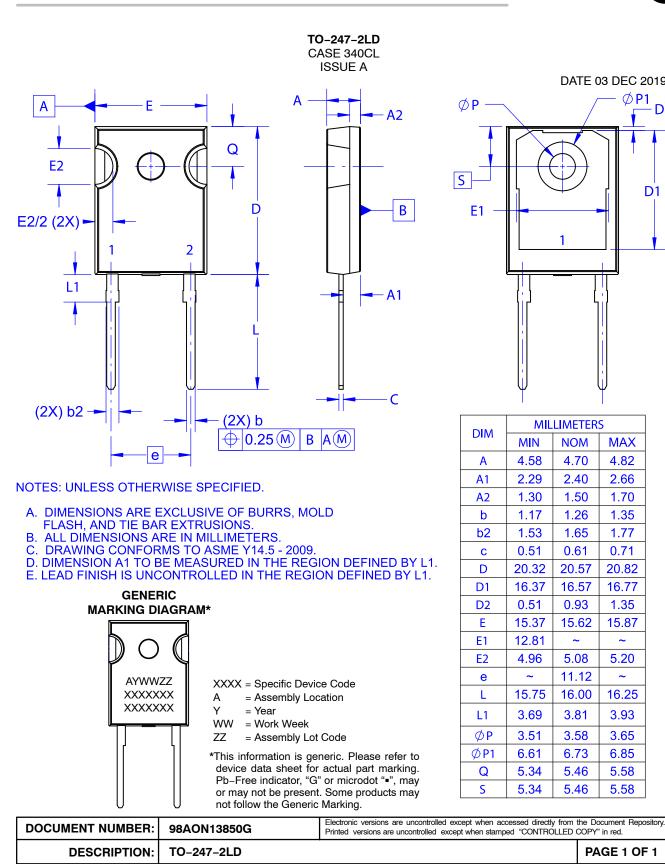
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